



# **Product Summary**

BV <sub>DSS</sub>	RDS(ON) Max	ID Ta = +25°C
20V	$24m\Omega @ V_{GS} = 4.5V$	7A
200	28mΩ @ V <sub>GS</sub> = 2.5V	5A

# **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Backlighting
- DC-DC Converters
- Power Management Functions

### N-CHANNEL ENHANCEMENT MODE MOSFET

# **Features and Benefits**

- Low On-Resistance
- Low-Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2024UVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

# **Mechanical Data**

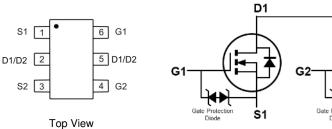
- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish—Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.013 grams (Approximate)





TSOT26

Protected Gate





D2

**S**2

# Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2024UVTQ-7	TSOT26	3,000/Tape & Reel
DMN2024UVTQ-13	TSOT26	10,000/Tape & Reel

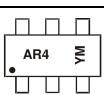
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



 $\begin{array}{l} \mathsf{AR4} = \mathsf{Product Type Marking Code} \\ \mathsf{YM} = \mathsf{Date Code Marking} \\ \mathsf{Y or } \overline{\mathsf{Y}} = \mathsf{Year} \ (\mathsf{ex: I} = 2021) \\ \mathsf{M} = \mathsf{Month} \ (\mathsf{ex: 9} = \mathsf{September}) \end{array}$ 

#### Date Code Key

Notes:

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	Н		J	K	L	М	N	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	20	V		
Gate-Source Voltage	VGSS	±10	V		
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$	lo	7.0 5.0	А		
Maximum Continuous Body Diode Forward Curr	ls	2.3	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	1%)		I <sub>DM</sub>	35	А

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1.0	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>eja</sub>	124	°C/W
Total Power Dissipation (Note 6)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Rəja	78	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	20	_	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	IDSS	—	_	1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	—	_	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	0.5	—	0.9	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
			19	24		$V_{GS} = 4.5V, I_{D} = 6.5A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	22	28	mΩ	$V_{GS} = 2.5V, I_{D} = 5.5A$	
			25	34		V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 3.5A	
Diode Forward Voltage	Vsd	—	0.9	1.2	V	$V_{GS} = 0V, I_D = 5A$	
DYNAMIC CHARACTERISTICS (Note 8)			-				
Input Capacitance	Ciss	_	647		pF		
Output Capacitance	Coss	—	78	—	pF	−V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V −f = 1.0MHz	
Reverse Transfer Capacitance	Crss	—	38		pF		
Gate Resistance	Rg	100	400	800	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	—	7.1	_	nC		
Gate-Source Charge	Qgs	—	0.9	—	nC	$V_{GS} = 4.5V, V_{DS} = 10V, I_{D} = 6.5A$	
Gate-Drain Charge	Qgd	—	0.7	—	nC		
Turn-On Delay Time	tD(ON)	_	98	_	ns		
Turn-On Rise Time	tR	—	140	—	ns	$V_{DS} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	tD(OFF)	—	1024	—	ns	$R_L=10\Omega,\ R_G=6\Omega,\ I_D=1A$	
Turn-Off Fall Time	tF	_	434	—	ns		
Reverse Recovery Time	trr		245		ns	IF = 1.0A, di/dt = 100A/µs	
Reverse Recovery Charge	Q <sub>RR</sub>	—	149	—	nC	I <sub>F</sub> = 1.0A, di/dt = 100A/µs	

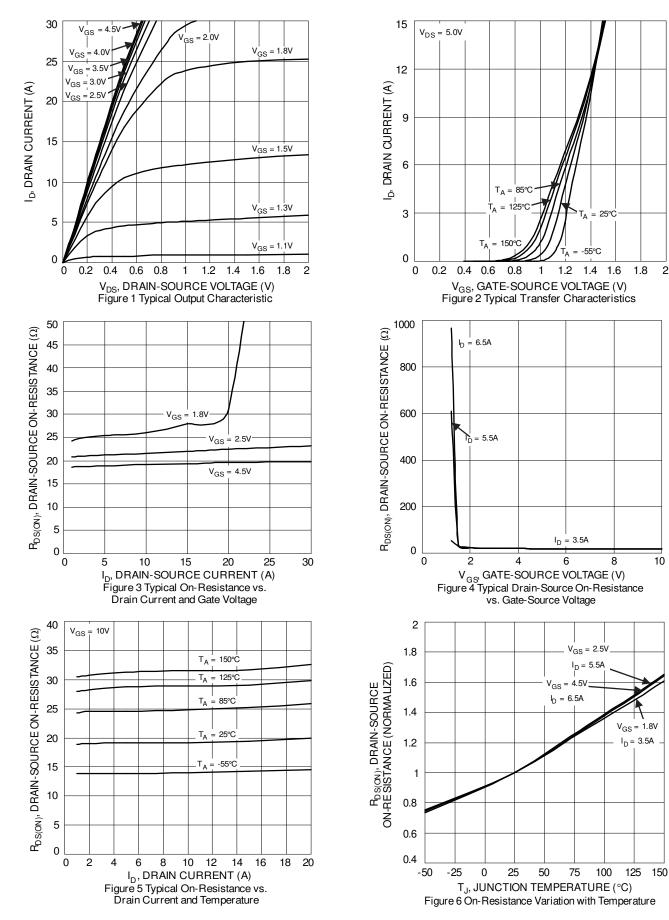
5. Device mounted on FR-4 PCB, with minimum recommended pad layout. Notes:

Device mounted on 1" x 1" FR-4 PCB with high-coverage 2oz. copper, single sided.
Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

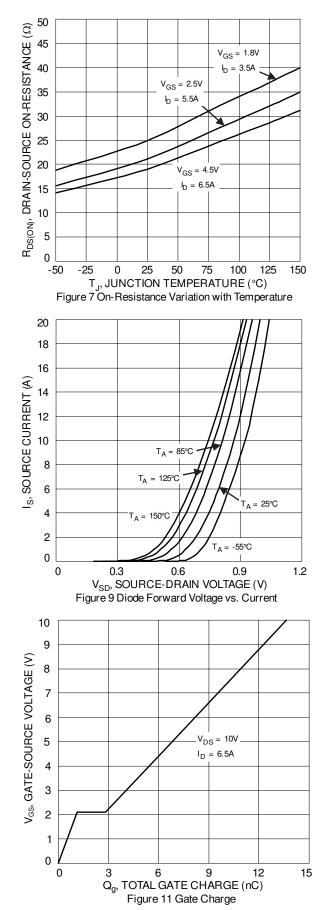


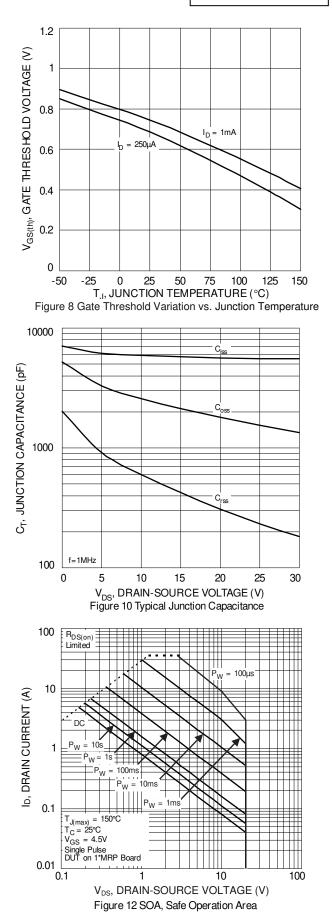
# DMN2024UVTQ



DMN2024UVTQ Document number: DS42664 Rev. 2 - 2

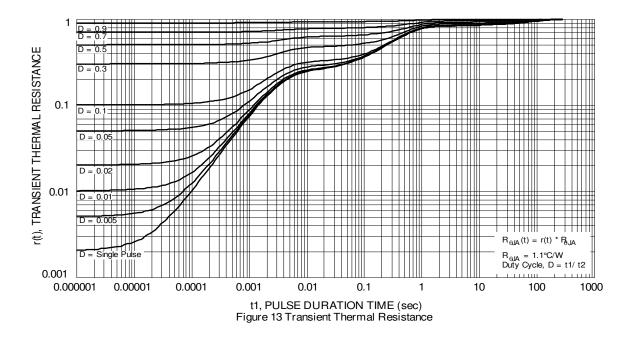






DMN2024UVTQ Document number: DS42664 Rev. 2 - 2

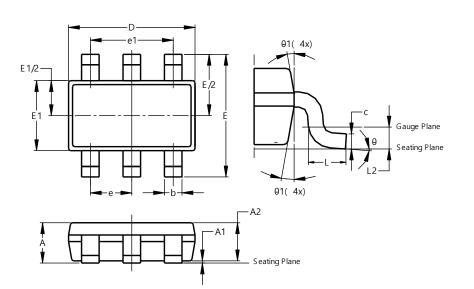






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

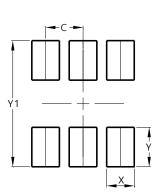


TSOT26							
Dim	Min	Min Max					
Α	1	1.00	-				
A1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
ш	2	.800 BS	С				
E1	1.500	1.700	1.600				
q	0.300	0.450	-				
c	0.120 0.200		-				
е	0.950 BSC						
e1	1	.900 BS	С				
L	0.30	0.50	-				
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	-				
Α	II Dimen	sions in	mm				

#### TSOT26

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200

TSOT26



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